

TITLE: MODIFIED CHIP ATTACH PROCESS AND APPARATUS  
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SERIAL NO.: 10/675,880

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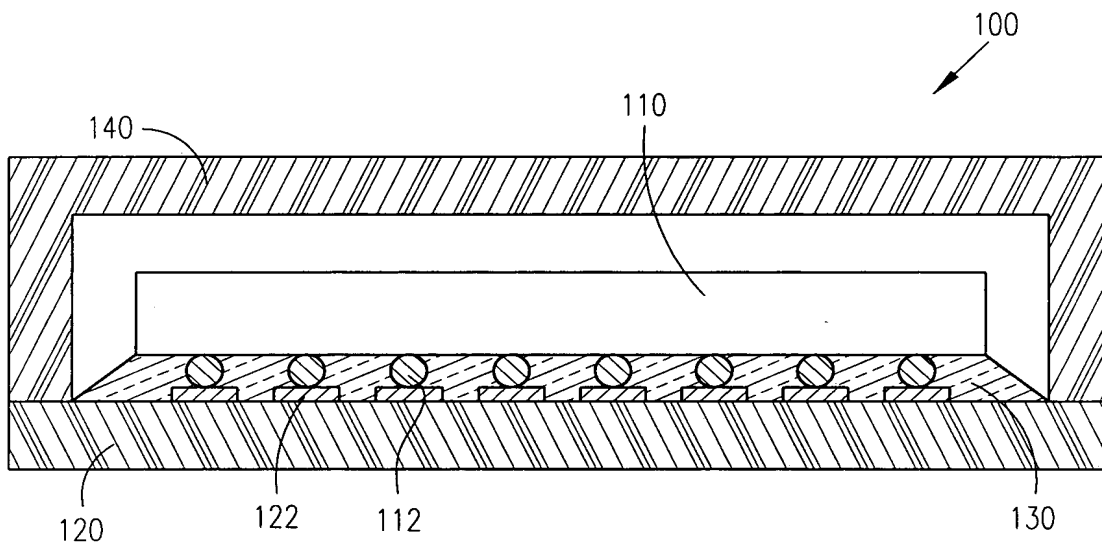


FIG. 1A

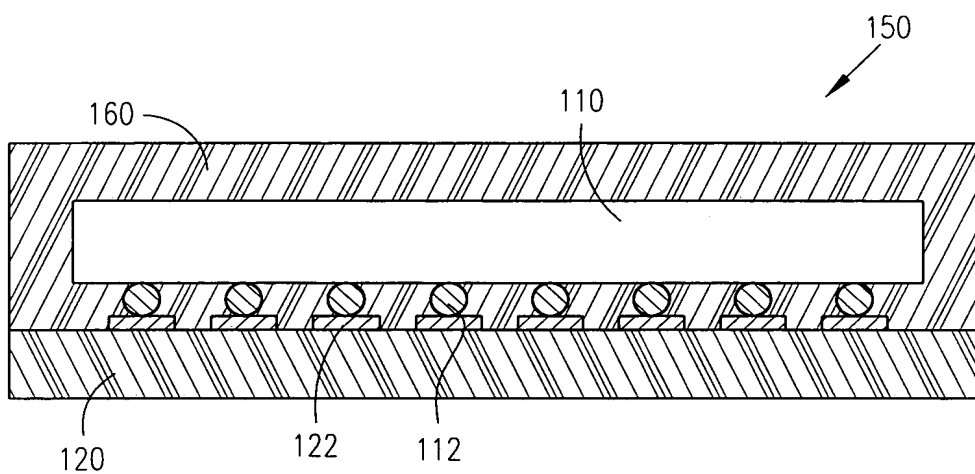


FIG. 1B

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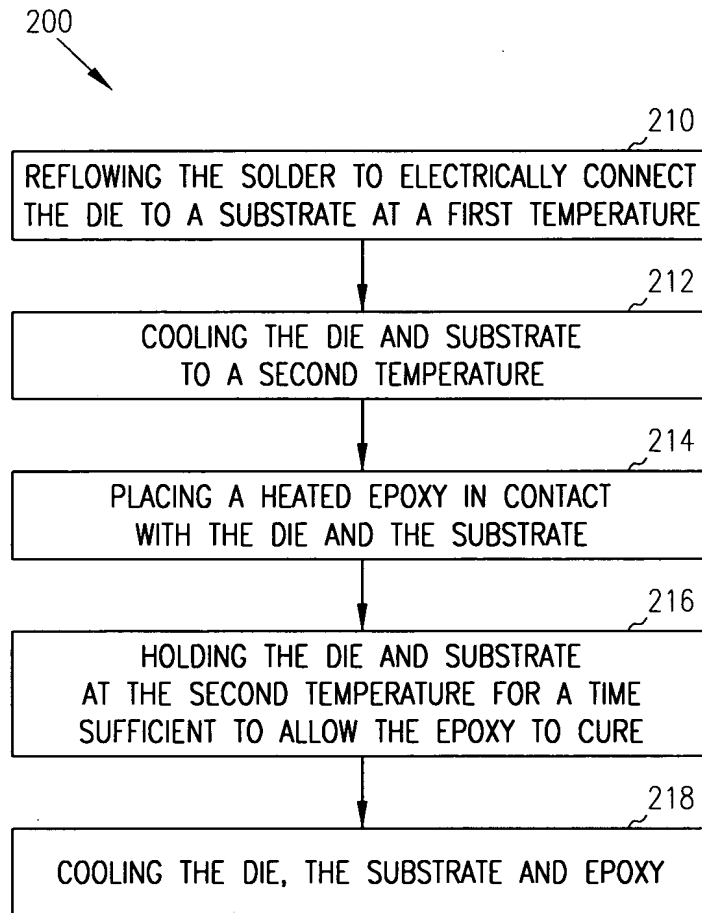


FIG. 2

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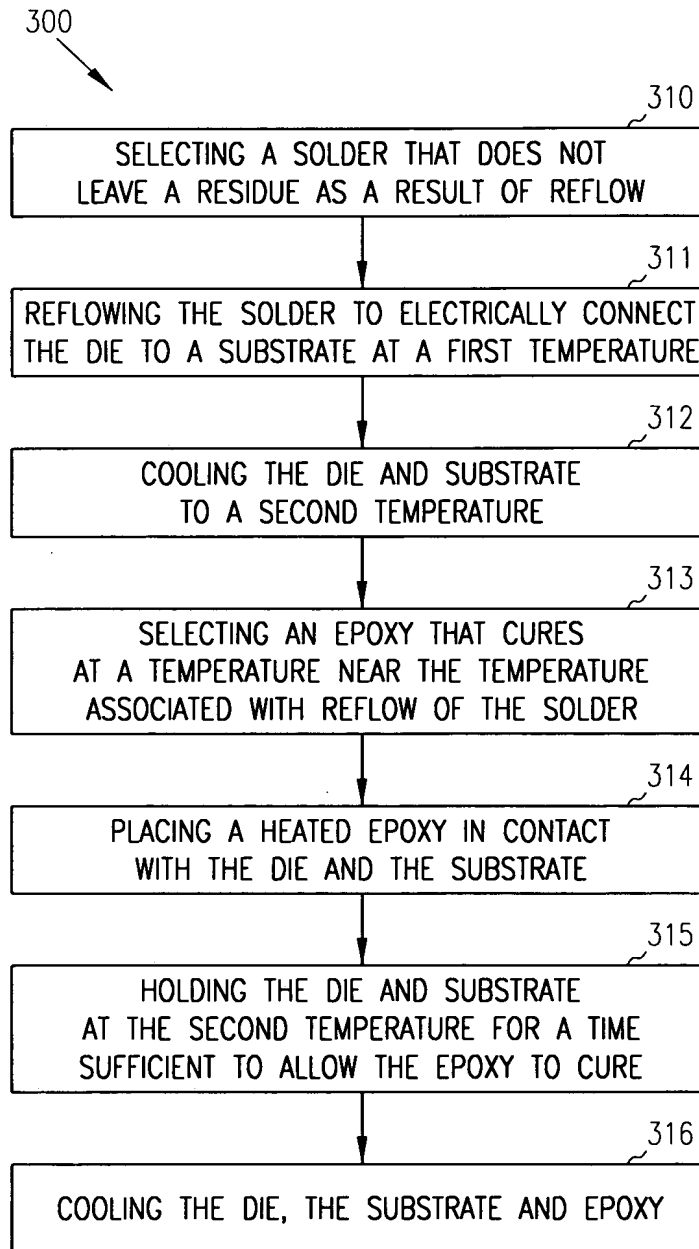


FIG. 3

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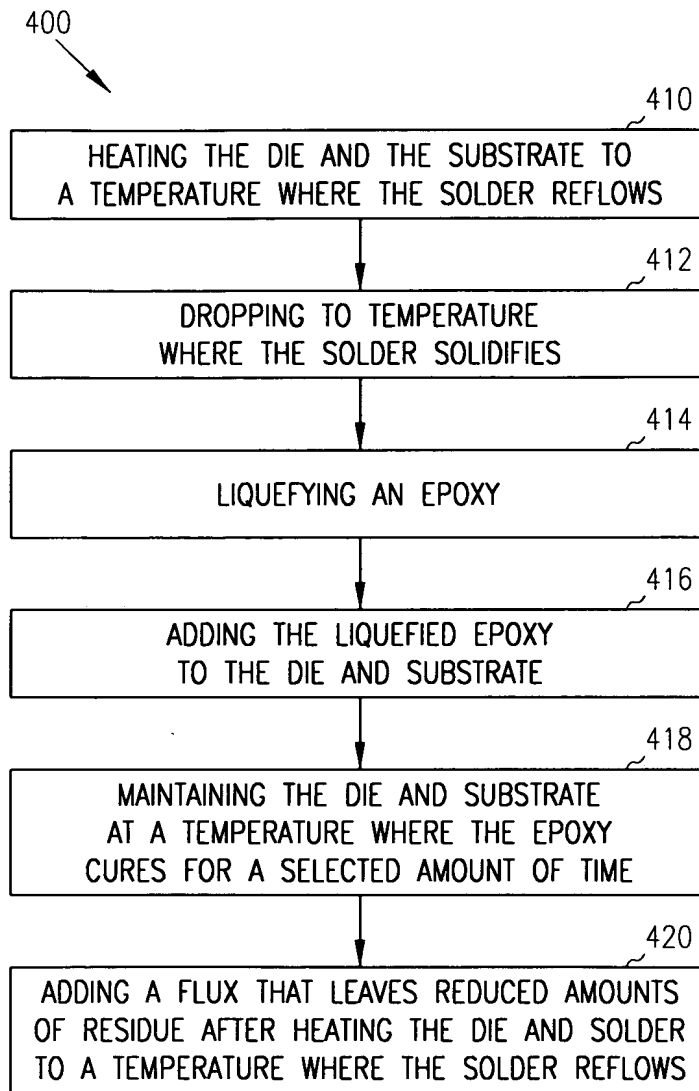


FIG. 4

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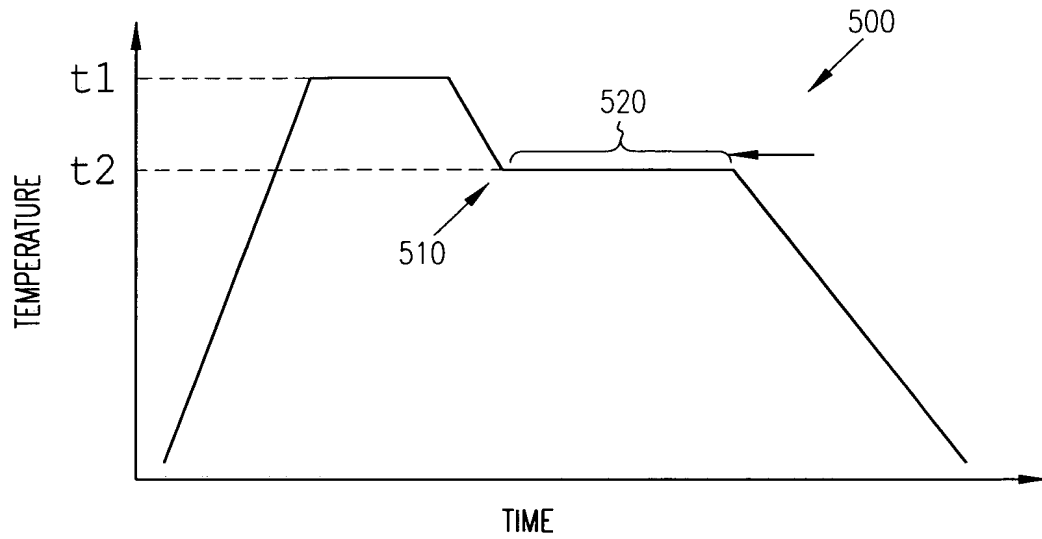


FIG. 5

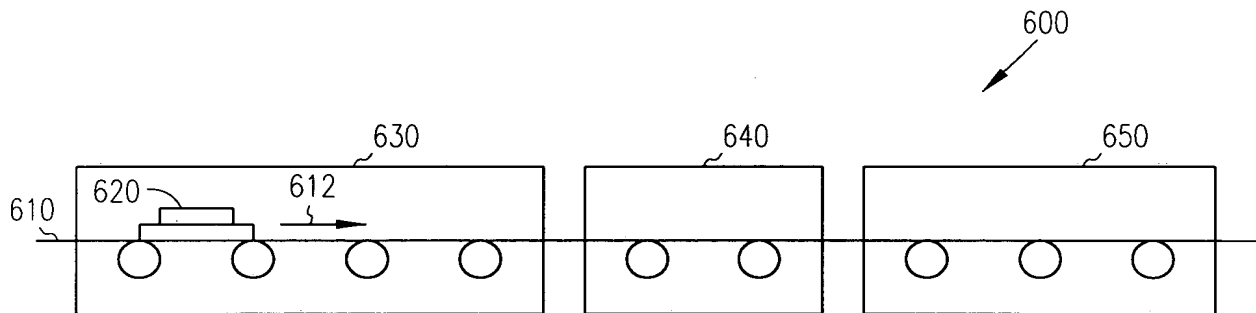


FIG. 6

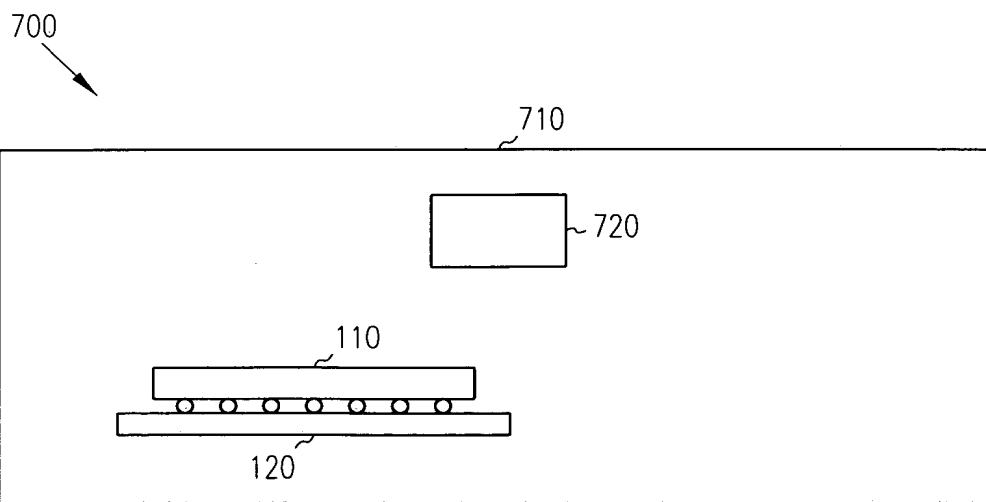


FIG. 7

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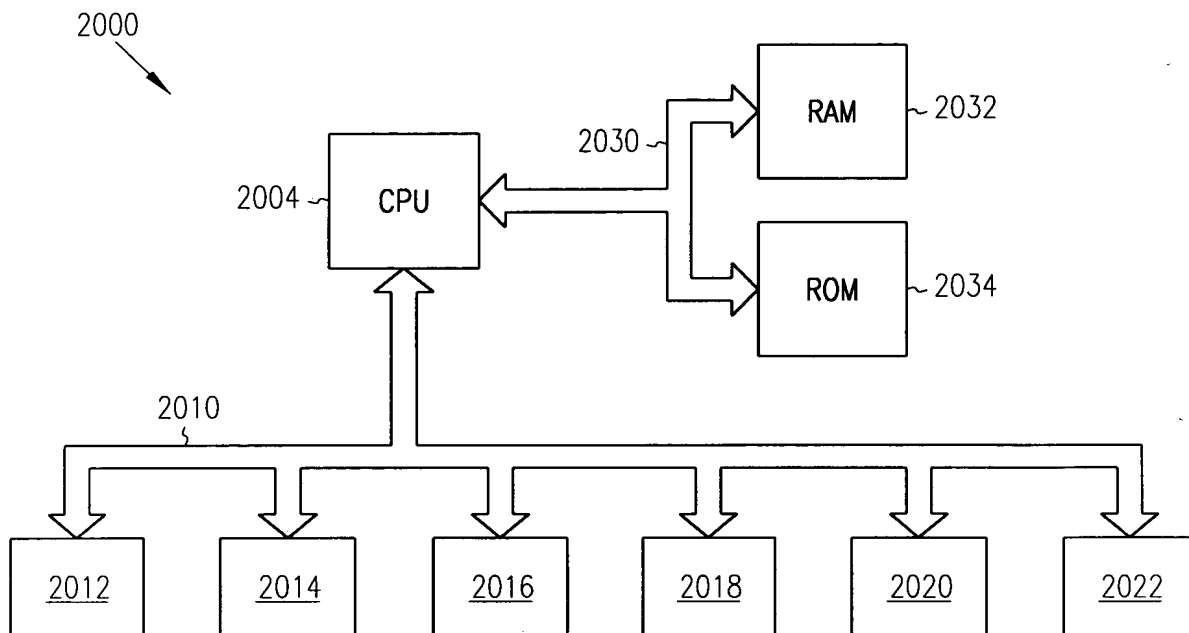


FIG. 8

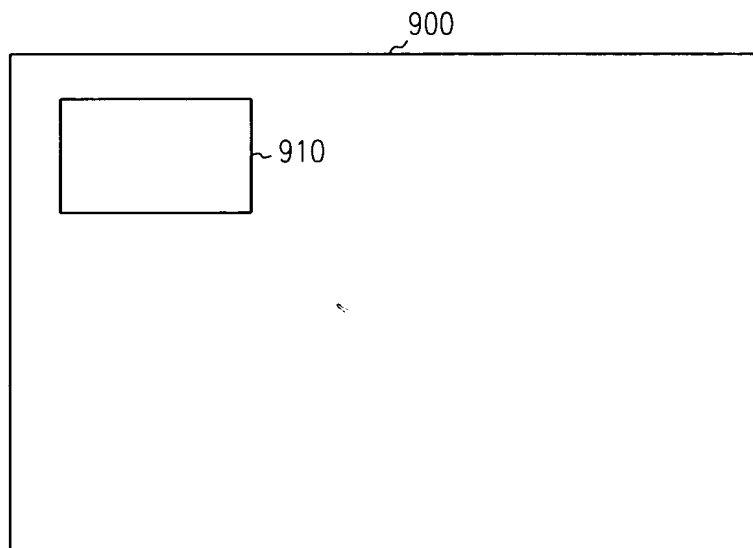


FIG. 9